



Patitioner's Docket No. 4492P1072US

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#12

In re application of: Batz, Robert W., Jr.
Application No.: 09/390,501
Filed: 09/03/1999
Examiner: Erica Smith-Hicks
Group No.: 1741
For: METHODS FOR PLATING SEMICONDUCTOR WORKPIECES
USING A WORKPIECE-ENGAGING ELECTRODE ASSEMBLY
WITH SEALING BOOT

Assistant Commissioner for Patents
Washington, D.C. 20231

CERTIFICATE OF MAILING UNDER 37 C.F.R. section 1.8(a)

I hereby certify that the attached correspondence comprising:

Issue Fee Transmittal
Formal Drawings (38 pgs)
Rule 312 Amendment with Application Data Sheet
Change of Correspondence Address
Postcard

is being deposited with the United States Postal Service, with sufficient postage, as first class mail in an envelope addressed to:

Assistant Commissioner for Patents
Washington, D.C. 20231

on June 27, 2001.

Robert B. Polit (33,993)